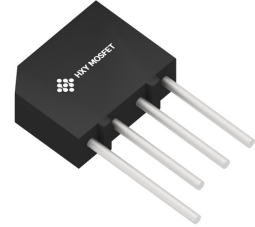




Features

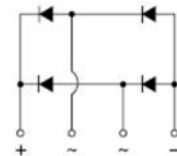
- This series is UL listed under the Recognized Component Index, file number E142814
- Ideal for printed circuit board mounting
- The plastic material used carries Underwriters Laboratory flammability recognition 94V-0
- Built-in printed circuit board stand-offs
- High case dielectric strength
- High temperature soldering guaranteed 265°C/10 seconds at 5 lbs (2.3kg) tension



**KBP
(KBPM)**

Ordering Information

| Product ID | Pack | Qty(PCS) |
|------------------|------|----------|
| 2KBP06M_B0_10001 | KBP | 500 |



Maximum Ratings (Ta=25°C unless otherwise noted)

| Parameter | Symbol | 2KBP06M_B0_10001 | Unit |
|---|------------------|------------------|--------------------|
| Maximum repetitive peak reverse voltage | VRRM | 600 | V |
| Maximum RMS bridge input voltage | VRMS | 420 | V |
| Maximum DC blocking voltage | VDC | 600 | V |
| Maximum average forward rectified output current at TA=50°C | IF(AV) | 2.0 | A |
| Peak forward surge current single sine-wave superimposed on rated load (JEDEC Method) | IFSM | 60 | A |
| Rating for fusing (t<8.3ms) | I ² t | 15.0 | A ² sec |
| Typical thermal resistance per element (1) | ReJA | 10.0 | °C / W |
| Typical junction capacitance per element (2) | Cj | 25.0 | pF |
| Operating junction and storage temperature range | TJ, TSTG | -55 to + 150 | °C |

Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified. Resistive or Inductive 60Hz load, For Capacitive load derate by 20 %.

| Parameter | Symbol | 2KBP06M_B0_10001 | Unit |
|---|--------|------------------|------|
| Maximum instantaneous forward voltage drop per leg at 2.0A | VF | 1.1 | V |
| Maximum DC reverse current at rated TA =25°C DC blocking voltage per element TA =125°C | IR | 10 500 | μA |

Notes: (1)Thermal resistance from Junction to Ambient on P.C.board mounting.
(2)Measured at 2.0MHz and applied reverse voltage of 4.0 volts.



Rating and Characteristic Curves ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Fig. 1 Derating Curve for
Output Rectified Current

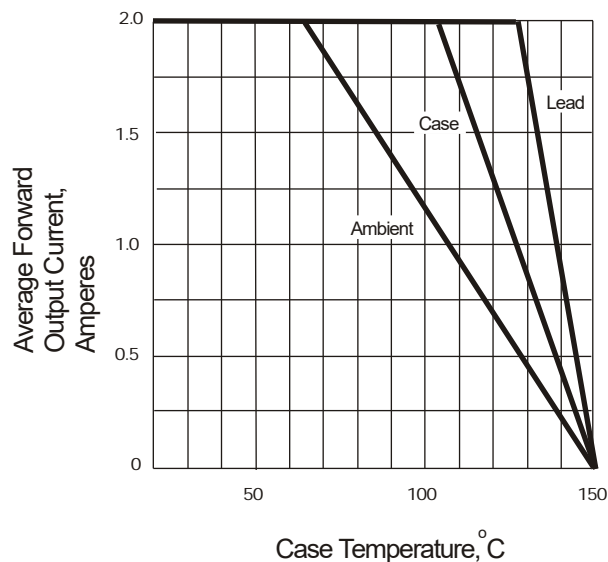


Fig. 2 Maximum Non-repetitive Peak
Forward Surge Current

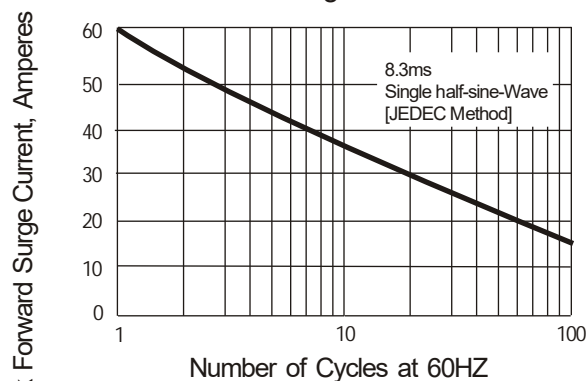


Fig. 3 Typical Instantaneous
Forward Characteristics

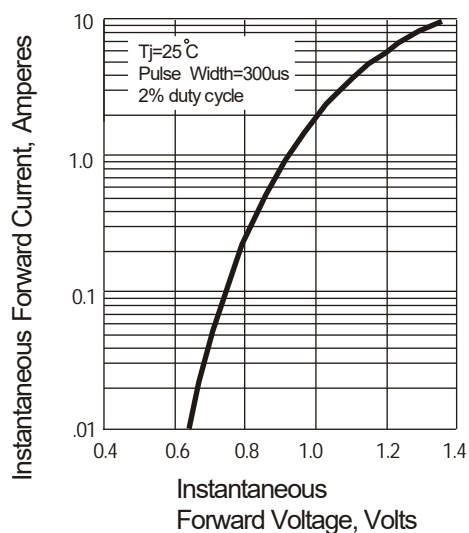


Fig. 4 Typical Reverse
Characteristics

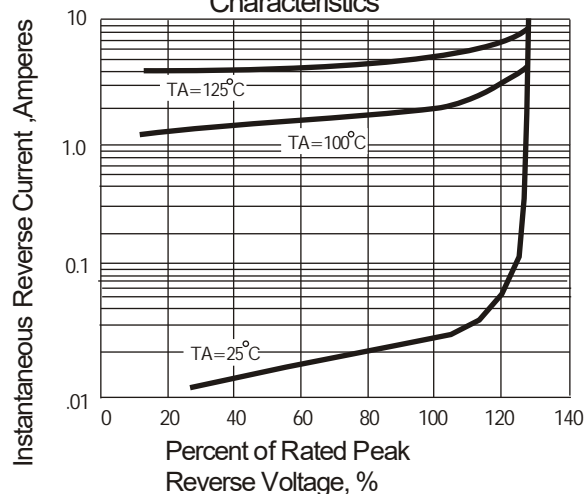
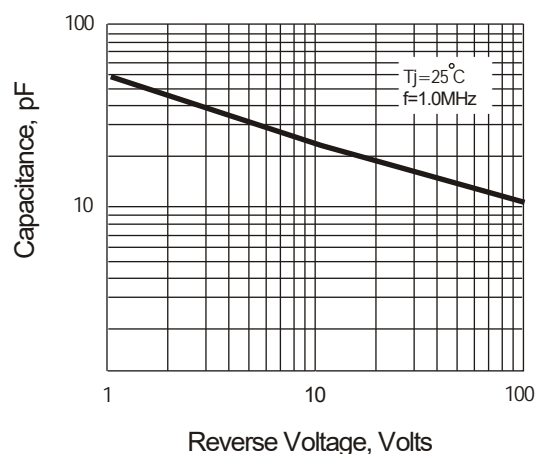
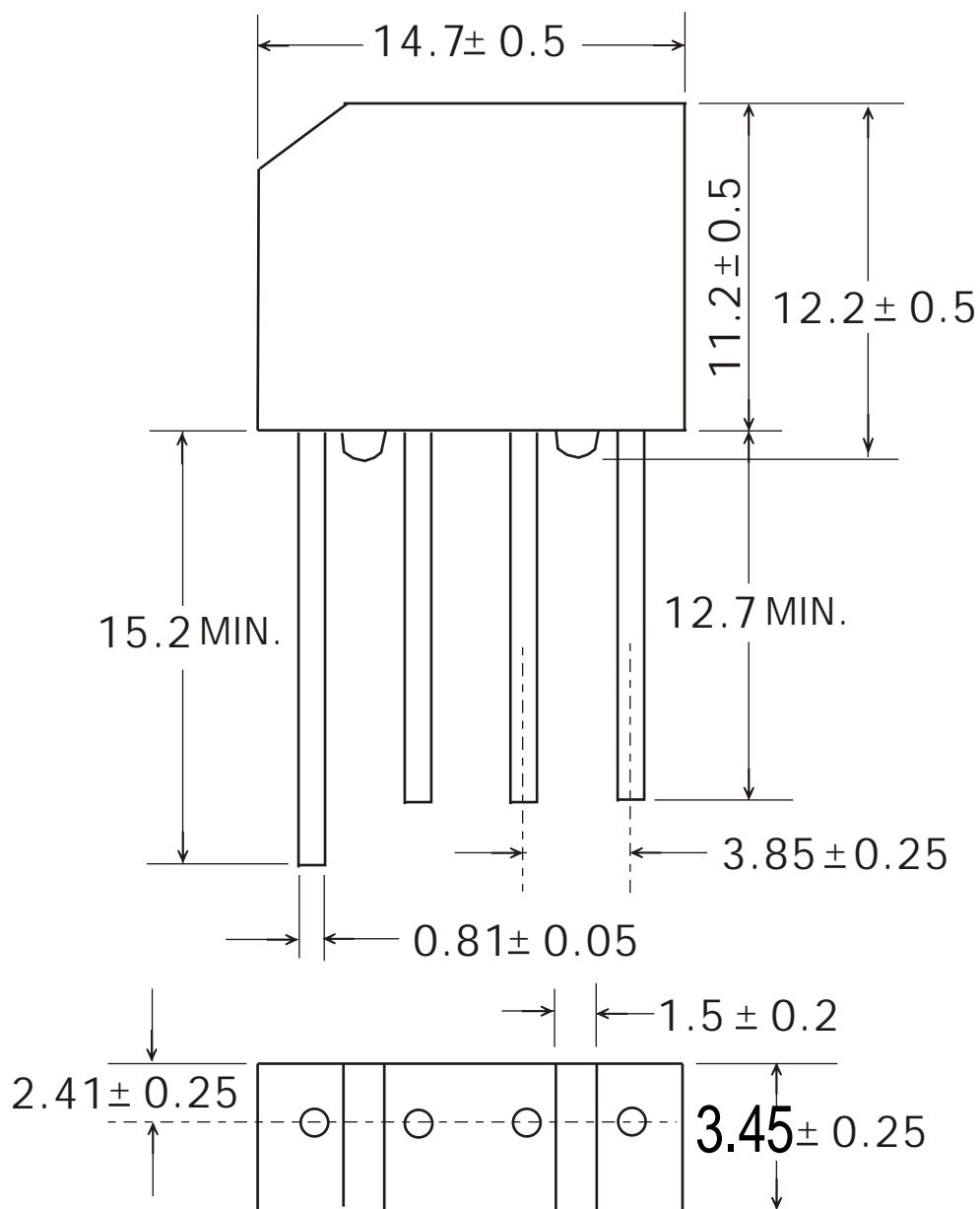


Fig. 5 Typical Junction Capacitance





KBP(KBPM) Package Outline Dimensions



Dimensions in millimeters(1mm =0.0394")



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